

A

B

C

D

E

F

A

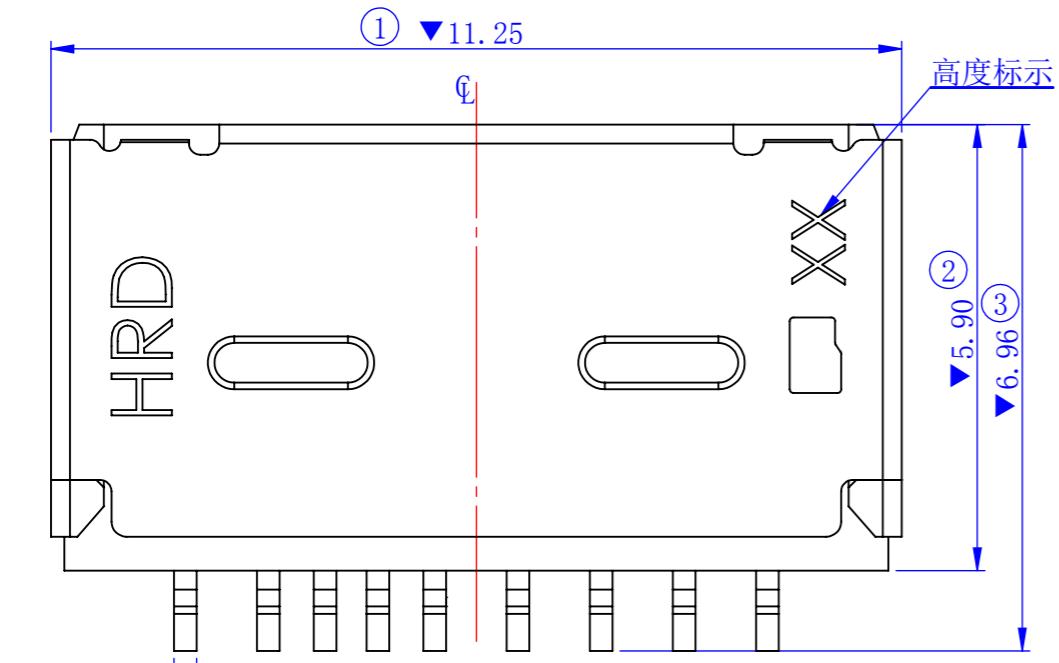
B

C

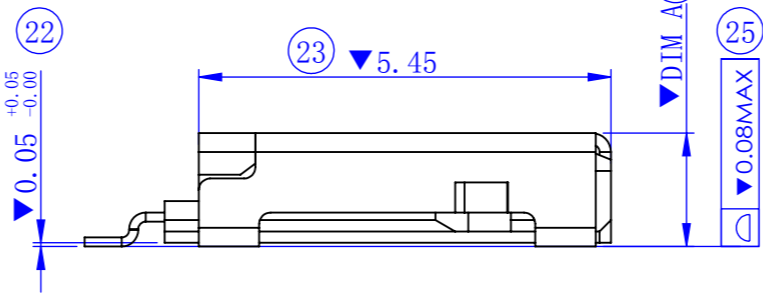
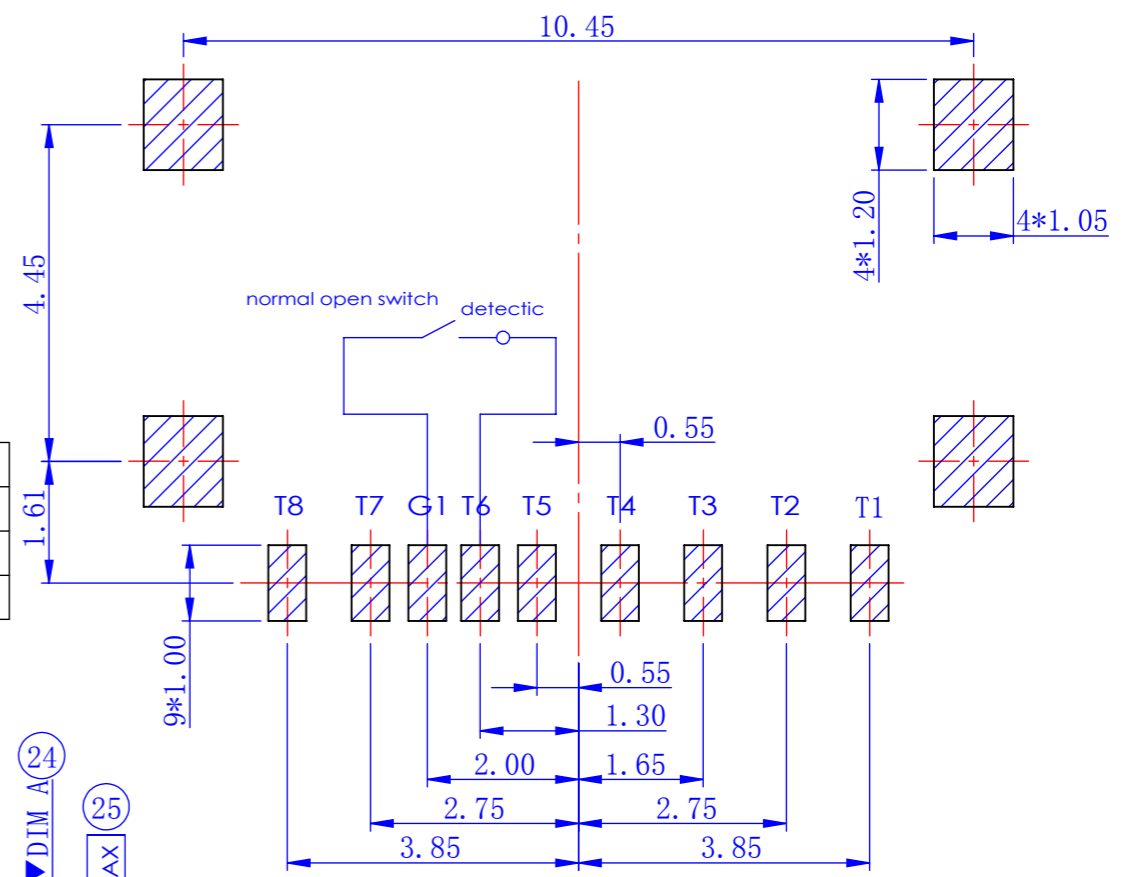
D

E

F



P/N	DIM A	高度标示
T11-BB09C140	1.42	14
T11-BB09C150	1.50	15
T11-BB09C170	1.70	17



- NOTES:
- MATERIAL:
HOUSING: LCP, BLACK, UL 94V-0
CONTACT: PHOSPHOR BRONZE, T=0.12MM
SHELL: STAINLESS STEEL T=0.15MM
 - FINISH:
CONTACT:
50U" NI MIN UNDER PLATED OVER ALL
AU 15U" MIN ON CONTACT, AU 1U" MIN SOLDER AREA
SHELL:
50U" NI MIN UNDER PLATED OVER ALL
AU 1U" MIN SOLDER AREA
 - ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
 - RATED PARAMETERS OF CONNECTOR
4-1. Operating temperature: -40°C to 70°C
4-2. Rated Current: 0.5A
4-3. Rated Voltage: 30V DC Per Contact
 - ELECTRICAL MECHANICAL ENVIRONMENTAL
5-1. Dielectric withstanding Voltage : 500V AC 1min.
5-2. Insulation Resistance: 1000 MΩ Min.
5-3. Normal Force: 30g Min. Per Pin
5-4. Durability: 3000 cycles
5-5. Contact Resistance: 50mΩ MAX.

T-CARD PIN NO.	PIN NO.
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1
G1	SWITCH

REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
				DATE: 05/11/2017	X. ±0.20 .X ±0.15 .XX ±0.10 .XXX ±0.05	X.° ±2.00° .X° ±1.00° .XX° ±0.50°	T11-BB09CXX0
				SCALE: 10/1		CHECKED:	TITLE: T-FLASH CARD 成品H=1.35&1.50&1.70mm
				SHEET: 1/1	MATERIAL:	APPROVE:	DRAWING NO:
				REV. B	FINISH: SEE NOTE		

 昆山捷皇电子精密科技有限公司
HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.